Renesas Electronics America Inc - R5F521A8BDFM#V0 Datasheet

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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	RX
Core Size	32-Bit Single-Core
Speed	50MHz
Connectivity	I²C, IrDA, SCI, SPI
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	38
Program Memory Size	512KB (512K x 8)
Program Memory Type	FLASH
EEPROM Size	8K x 8
RAM Size	64K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.6V
Data Converters	A/D 3x24b, 4x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	64-LQFP
Supplier Device Package	64-LFQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f521a8bdfm-v0

1. Overview

1.1 Outline of Specifications

Table 1.1 shows the outline of the specifications and Table 1.2 shows the comparison of the functions of products in different packages.
Table 1.1 is for products with the greatest number of functions, so numbers of peripheral modules and channels will differ in accord with the package. For details, see Table 1.2, Comparison of Functions for Different Packages.

Table 1.1 Outline of Specifications (1 / 4)

Classification	Module/Function	Description
CPU	CPU	• Maximum operating frequency: 50 MHz • 32-bit RX CPU • Minimum instruction execution time: One instruction per state (cycle of the system clock) • Address space: 4-Gbyte linear • Register set General purpose: Sixteen 32-bit registers Control: Eight 32-bit registers Accumulator: One 64-bit register • Basic instructions: 73 • DSP instructions: 9 • Addressing modes: 10 • Data arrangement Instructions: Little endian Data: Selectable as little endian or big endian • On-chip 32-bit multiplier: 32 x 32 → 64 bits • On-chip divider: 32 / 32 → 32 bits • Barrel shifter: 32 bits • Memory protection unit (MPU)
Memory	ROM	• Capacity: 256 K/384 K/512 Kbytes • 50 MHz, no-wait memory access • On-board programming: 3 types
	RAM	• Capacity:32 K/64 Kbytes • 50 MHz, no-wait memory access
	E2 DataFlash	• Capacity: 8 Kbytes • Number of times for programming/erasing: 100,000
MCU operating mode		Single-chip mode
Clock	Clock generation circuit	• Main clock oscillator, sub-clock oscillator, low-speed on-chip oscillator, high-speed on-chip oscillator, PLL frequency synthesizer, and IWDT-dedicated on-chip oscillator • Oscillation stop detection • Measuring circuit for accuracy of clock frequency (clock-accuracy check: CAC) • Independent settings for the system clock (ICLK), peripheral module clock (PCLK), and FlashIF clock (FCLK) The CPU and system sections such as other bus masters run in synchronization with the system clock (ICLK): 50 MHz (at max.) Peripheral modules run in synchronization with the peripheral module clock (PCLK):25 MHz (at max.) The flash peripheral circuit runs in synchronization with the flash peripheral clock (FCLK): 25 MHz (at max.)
Reset		RES# pin reset, power-on reset, voltage monitoring reset, watchdog timer reset, independent watchdog timer reset, deep software standby reset, and software reset
Voltage detection	Voltage detection circuit (LVDAa)	• When the voltage on VCC falls below the voltage detection level, an internal reset or internal interrupt is generated. Voltage detection circuit 0 is capable of selecting the detection voltage from 2 levels Voltage detection circuit 1 is capable of selecting the detection voltage from 9 levels Voltage detection circuit 2 is capable of selecting the detection voltage from 9 levels
Low power consumption	Low power consumption facilities	• Module stop function • Four low power consumption modes Sleep mode, all-module clock stop mode, software standby mode, and deep software standby mode
	Function for lower operating power consumption	High-speed operating mode, middle-speed operating mode 1A, middle-speed operating mode 1B, middle-speed operating mode 2A, middle-speed operating mode 2B, low-speed operating mode 1, low-speed operating mode 2
Interrupt	Interrupt controller (ICUb)	• Interrupt vectors: 122 • External interrupts: 9 (NMI and IRQ0 to IRQ7 pins) • Non-maskable interrupts: 6 (the NMI pin, oscillation stop detection interrupt, voltage monitoring 1 interrupt, voltage monitoring 2 interrupt, WDT interrupt, and IWDT interrupt) • 16 levels specifiable for the order of priority

Table 1.5 List of Pins and Pin Functions (100-Pin LQFP) (1 / 3)

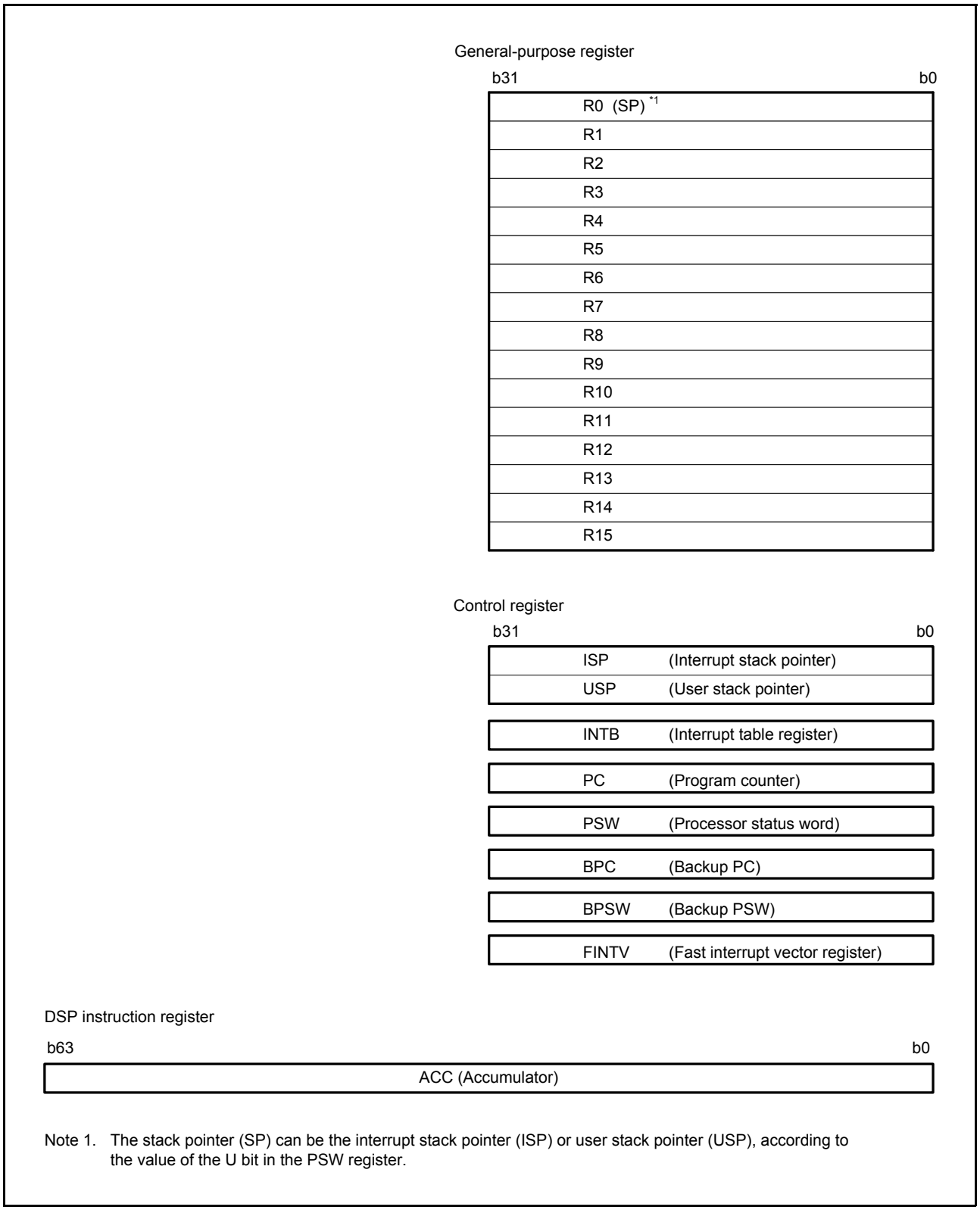
Pin No.	Power Supply, Clock, System Control	I/O Port	Timers (MTU, TMR, POE)	Communications (SCIc, RSPI, RIIC)	Others
1	VREFH				
2		P03			AN4/DA0
3	VREFL				
4		PJ3	MTIOC3C	CTS6#/RTS6#/SS6#	
5	VCL				
6		PJ1	MTIOC3A		
7	MD				FINED
8	XCIN				
9	XCOUT				
10	RES#				
11	XTAL	P37			
12	VSS				
13	EXTAL	P36			
14	VCC				
15		P35			NMI
16		P34	MTIOC0A/TMCI3/POE2#	SCK6	IRQ4
17		P33	MTIOC0D/TMRI3/POE3#	RXD6/SMISO6/SSCL6	IRQ3-DS
18		P32	MTIOC0C/TMO3	TXD6/SMOSI6/SSDA6	IRQ2-DS/RTCOUT/ RTCIC2
19		P31	MTIOC4D/TMCI2	CTS1#/RTS1#/SS1#/SSLB0	IRQ1-DS/RTCIC1
20		P30	MTIOC4B/TMRI3/POE8#	RXD1/SMISO1/SSCL1/ MISOB	IRQ0-DS/RTCIC0
21		P27	MTIOC2B/TMCI3	SCK1/RSPCKB	
22		P26	MTIOC2A/TMO1	TXD1/SMOSI1/SSDA1/ MOSIB	
23		P25	MTIOC4C/MTCLKB		ADTRG0#
24		P24	MTIOC4A/MTCLKA/TMRI1		
25		P23	MTIOC3D/MTCLKD		
26		P22	MTIOC3B/MTCLKC/TMO0		
27		P21	MTIOC1B/TMCI0	SCL1	
28		P20	MTIOC1A/TMRI0	SDA1	
29		P17	MTIOC3A/MTIOC3B/TMO1/ POE8#	SCK1/MISOA/SDA0-DS	IRQ7
30		P16	MTIOC3C/MTIOC3D/TMO2	TXD1/SMOSI1/SSDA1/ MOSIA/SCL0-DS	IRQ6/RTCOUT/ ADTRG0#
31		P15	MTIOC0B/MTCLKB/TMCI2	RXD1/SMISO1/SSCL1	IRQ5
32		P14	MTIOC3A/MTCLKA/TMRI2	CTS1#/RTS1#/SS1#	IRQ4
33		P13	MTIOC0B/TMO3	SDA0	IRQ3
34		P12	TMCI1	SCL0	IRQ2
35		PH3	TMCI0		
36		PH2	TMRI0		IRQ1
37		PH1	TMO0		IRQ0
38		PH0			CACREF
39		P55	MTIOC4D/TMO3		
40		P54	MTIOC4B/TMCI1		
41		P53			

Table 1.8 List of Pins and Pin Functions (100-Pin TFLGA) (2 / 3)

Pin No.	Power Supply, Clock, System Control	I/O Port	Timers (MTU, TMR, POE)	Communications (SCIc, RSPI, RIIC)	Others
E6		PA2		RXD5/SMISO5/SSCL5/ IRRXD5/SSLA3	CMPA2
E7		PA6	MTIC5V/MTCLKB/TMCI3/ POE2#	CTS5#/RTS5#/SS5#/MOSIA	CVREFB0
E8		PA4	MTIC5U/MTCLKA/TMRI0	TXD5/SMOSI5/SSDA5/ IRTXD5/SSLA0	IRQ5-DS/CVREFB1
E9		PA5		RSPCKA	
E10		PA3	MTIOC0D/MTCLKD	RXD5/SMISO5/SSCL5/ IRRXD5	IRQ6-DS/CMPB1
F1	EXTAL	P36			
F2	VCC				
F3		P35			NMI
F4		P32	MTIOC0C/TMO3	TXD6/SMOSI6/SSDA6	IRQ2-DS/RTCOUT/ RTCIC2
F5		P12	TMCI1	SCL0	IRQ2
F6		PB3	MTIOC0A/MTIOC4A/TMO0/ POE3#	SCK6	
F7		PB2		CTS6#/RTS6#/SS6#	
F8		PB0	MTIC5W	RXD6/SMISO6/SSCL6/ RSPCKA	CMPB0
F9		PA7		MISOA	
F10	VSS				
G1		P33	MTIOC0D/TMRI3/POE3#	RXD6/SMISO6/SSCL6	IRQ3-DS
G2		P31	MTIOC4D/TMCI2	CTS1#/RTS1#/SS1#/SSLB0	IRQ1-DS/RTCIC1
G3		P30	MTIOC4B/TMRI3/POE8#	RXD1/SMISO1/SSCL1/ MISOB	IRQ0-DS/RTCIC0
G4		P27	MTIOC2B/TMCI3	SCK1/RSPCKB	
G5		P53			
G6		P52		SSLB3	
G7		PB5	MTIOC2A/MTIOC1B/TMRI1/ POE1#	SCK9	
G8		PB4		CTS9#/RTS9#/SS9#	
G9		PB1	MTIOC0C/MTIOC4C/TMCI0	TXD6/SMOSI6/SSDA6	IRQ4-DS
G10	VCC				
H1		P26	MTIOC2A/TMO1	TXD1/SMOSI1/SSDA1/ MOSIB	
H2		P25	MTIOC4C/MTCLKB		ADTRG0#
H3		P16	MTIOC3C/MTIOC3D/TMO2	TXD1/SMOSI1/SSDA1/ MOSIA/SCL0-DS	IRQ6/RTCOUT/ ADTRG0#
H4		P15	MTIOC0B/MTCLKB/TMCI2	RXD1/SMISO1/SSCL1	IRQ5
H5		P55	MTIOC4D/TMO3		
H6		P54	MTIOC4B/TMCI1		
H7		PC7	MTIOC3A/TMO2/MTCLKB	TXD8/SMOSI8/SSDA8/ MISOA	CACREF
H8		PC6	MTIOC3C/MTCLKA/TMCI2	RXD8/SMISO8/SSCL8/ MOSIA	
H9		PB6	MTIOC3D	RXD9/SMISO9/SSCL9	
H10		PB7	MTIOC3B	TXD9/SMOSI9/SSDA9	
J1		P24	MTIOC4A/MTCLKA/TMRI1		

2. CPU

Figure 2.1 shows the register set of the CPU.



Note 1. The stack pointer (SP) can be the interrupt stack pointer (ISP) or user stack pointer (USP), according to the value of the U bit in the PSW register.

Figure 2.1 Register Set of the CPU

Table 4.1 List of I/O Registers (Address Order) (6 / 24)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access Cycles: ICLK ≥ PCLK	Number of Access Cycles: ICLK < PCLK
0008 7145h	ICU	DTC activation enable register 069	DTCER069	8	8		2 ICLK
0008 7146h	ICU	DTC activation enable register 070	DTCER070	8	8		2 ICLK
0008 7147h	ICU	DTC activation enable register 071	DTCER071	8	8		2 ICLK
0008 7162h	ICU	DTC activation enable register 098	DTCER098	8	8		2 ICLK
0008 716Ah	ICU	DTC activation enable register 106	DTCER106	8	8		2 ICLK
0008 716Bh	ICU	DTC activation enable register 107	DTCER107	8	8		2 ICLK
0008 716Ch	ICU	DTC activation enable register 108	DTCER108	8	8		2 ICLK
0008 716Dh	ICU	DTC activation enable register 109	DTCER109	8	8		2 ICLK
0008 7172h	ICU	DTC activation enable register 114	DTCER114	8	8		2 ICLK
0008 7173h	ICU	DTC activation enable register 115	DTCER115	8	8		2 ICLK
0008 7174h	ICU	DTC activation enable register 116	DTCER116	8	8		2 ICLK
0008 7175h	ICU	DTC activation enable register 117	DTCER117	8	8		2 ICLK
0008 7179h	ICU	DTC activation enable register 121	DTCER121	8	8		2 ICLK
0008 717Ah	ICU	DTC activation enable register 122	DTCER122	8	8		2 ICLK
0008 717Dh	ICU	DTC activation enable register 125	DTCER125	8	8		2 ICLK
0008 717Eh	ICU	DTC activation enable register 126	DTCER126	8	8		2 ICLK
0008 7181h	ICU	DTC activation enable register 129	DTCER129	8	8		2 ICLK
0008 7182h	ICU	DTC activation enable register 130	DTCER130	8	8		2 ICLK
0008 7183h	ICU	DTC activation enable register 131	DTCER131	8	8		2 ICLK
0008 7184h	ICU	DTC activation enable register 132	DTCER132	8	8		2 ICLK
0008 7186h	ICU	DTC activation enable register 134	DTCER134	8	8		2 ICLK
0008 7187h	ICU	DTC activation enable register 135	DTCER135	8	8		2 ICLK
0008 7188h	ICU	DTC activation enable register 136	DTCER136	8	8		2 ICLK
0008 7189h	ICU	DTC activation enable register 137	DTCER137	8	8		2 ICLK
0008 718Ah	ICU	DTC activation enable register 138	DTCER138	8	8		2 ICLK
0008 718Bh	ICU	DTC activation enable register 139	DTCER139	8	8		2 ICLK
0008 718Ch	ICU	DTC activation enable register 140	DTCER140	8	8		2 ICLK
0008 718Dh	ICU	DTC activation enable register 141	DTCER141	8	8		2 ICLK
0008 71AEh	ICU	DTC activation enable register 174	DTCER174	8	8		2 ICLK
0008 71AFh	ICU	DTC activation enable register 175	DTCER175	8	8		2 ICLK
0008 71B1h	ICU	DTC activation enable register 177	DTCER177	8	8		2 ICLK
0008 71B2h	ICU	DTC activation enable register 178	DTCER178	8	8		2 ICLK
0008 71B4h	ICU	DTC activation enable register 180	DTCER180	8	8		2 ICLK
0008 71B5h	ICU	DTC activation enable register 181	DTCER181	8	8		2 ICLK
0008 71B7h	ICU	DTC activation enable register 183	DTCER183	8	8		2 ICLK
0008 71B8h	ICU	DTC activation enable register 184	DTCER184	8	8		2 ICLK
0008 71C6h	ICU	DTC activation enable register 198	DTCER198	8	8		2 ICLK
0008 71C7h	ICU	DTC activation enable register 199	DTCER199	8	8		2 ICLK
0008 71C8h	ICU	DTC activation enable register 200	DTCER200	8	8		2 ICLK
0008 71C9h	ICU	DTC activation enable register 201	DTCER201	8	8		2 ICLK
0008 71CFh	ICU	DTC activation enable register 207	DTCER207	8	8		2 ICLK
0008 71D0h	ICU	DTC activation enable register 208	DTCER208	8	8		2 ICLK
0008 71D1h	ICU	DTC activation enable register 209	DTCER209	8	8		2 ICLK
0008 71D2h	ICU	DTC activation enable register 210	DTCER210	8	8		2 ICLK
0008 71D3h	ICU	DTC activation enable register 211	DTCER211	8	8		2 ICLK
0008 71D4h	ICU	DTC activation enable register 212	DTCER212	8	8		2 ICLK
0008 71D5h	ICU	DTC activation enable register 213	DTCER213	8	8		2 ICLK
0008 71DBh	ICU	DTC activation enable register 219	DTCER219	8	8		2 ICLK
0008 71DCh	ICU	DTC activation enable register 220	DTCER220	8	8		2 ICLK
0008 71DFh	ICU	DTC activation enable register 223	DTCER223	8	8		2 ICLK
0008 71E0h	ICU	DTC activation enable register 224	DTCER224	8	8		2 ICLK

Table 4.1 List of I/O Registers (Address Order) (12 / 24)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access Cycles: ICLK ≥ PCLK	Number of Access Cycles: ICLK < PCLK
0008 83A1h	RSPI1	RSPI slave select polarity register	SSLP	8	8	2, 3 PCLKB	2 ICLK
0008 83A2h	RSPI1	RSPI pin control register	SPPCR	8	8	2, 3 PCLKB	2 ICLK
0008 83A3h	RSPI1	RSPI status register	SPSR	8	8	2, 3 PCLKB	2 ICLK
0008 83A4h	RSPI1	RSPI data register	SPDR	32	16, 32	2, 3 PCLKB	2 ICLK
0008 83A8h	RSPI1	RSPI sequence control register	SPSCR	8	8	2, 3 PCLKB	2 ICLK
0008 83A9h	RSPI1	RSPI sequence status register	SPSSR	8	8	2, 3 PCLKB	2 ICLK
0008 83AAh	RSPI1	RSPI bit rate register	SPBR	8	8	2, 3 PCLKB	2 ICLK
0008 83ABh	RSPI1	RSPI data control register	SPDCR	8	8	2, 3 PCLKB	2 ICLK
0008 83ACh	RSPI1	RSPI clock delay register	SPCKD	8	8	2, 3 PCLKB	2 ICLK
0008 83ADh	RSPI1	RSPI slave select negation delay register	SSLND	8	8	2, 3 PCLKB	2 ICLK
0008 83AEh	RSPI1	RSPI next-access delay register	SPND	8	8	2, 3 PCLKB	2 ICLK
0008 83AFh	RSPI1	RSPI control register 2	SPCR2	8	8	2, 3 PCLKB	2 ICLK
0008 83B0h	RSPI1	RSPI command register 0	SPCMD0	16	16	2, 3 PCLKB	2 ICLK
0008 83B2h	RSPI1	RSPI command register 1	SPCMD1	16	16	2, 3 PCLKB	2 ICLK
0008 83B4h	RSPI1	RSPI command register 2	SPCMD2	16	16	2, 3 PCLKB	2 ICLK
0008 83B6h	RSPI1	RSPI command register 3	SPCMD3	16	16	2, 3 PCLKB	2 ICLK
0008 83B8h	RSPI1	RSPI command register 4	SPCMD4	16	16	2, 3 PCLKB	2 ICLK
0008 83BAh	RSPI1	RSPI command register 5	SPCMD5	16	16	2, 3 PCLKB	2 ICLK
0008 83BCh	RSPI1	RSPI command register 6	SPCMD6	16	16	2, 3 PCLKB	2 ICLK
0008 83BEh	RSPI1	RSPI command register 7	SPCMD7	16	16	2, 3 PCLKB	2 ICLK
0008 8410h	IRDA	IrDA control register	IRCR	8	8	2, 3 PCLKB	2 ICLK
0008 8600h	MTU3	Timer control register	TCR	8	8	2, 3 PCLKB	2 ICLK
0008 8601h	MTU4	Timer control register	TCR	8	8	2, 3 PCLKB	2 ICLK
0008 8602h	MTU3	Timer mode register	TMDR	8	8	2, 3 PCLKB	2 ICLK
0008 8603h	MTU4	Timer mode register	TMDR	8	8	2, 3 PCLKB	2 ICLK
0008 8604h	MTU3	Timer I/O control register H	TIORH	8	8	2, 3 PCLKB	2 ICLK
0008 8605h	MTU3	Timer I/O control register L	TIORL	8	8	2, 3 PCLKB	2 ICLK
0008 8606h	MTU4	Timer I/O control register H	TIORH	8	8	2, 3 PCLKB	2 ICLK
0008 8607h	MTU4	Timer I/O control register L	TIORL	8	8	2, 3 PCLKB	2 ICLK
0008 8608h	MTU3	Timer interrupt enable register	TIER	8	8	2, 3 PCLKB	2 ICLK
0008 8609h	MTU4	Timer interrupt enable register	TIER	8	8	2, 3 PCLKB	2 ICLK
0008 860Ah	MTU	Timer output master enable register	TOER	8	8	2, 3 PCLKB	2 ICLK
0008 860Dh	MTU	Timer gate control register	TGCR	8	8	2, 3 PCLKB	2 ICLK
0008 860Eh	MTU	Timer output control register 1	TOCR1	8	8	2, 3 PCLKB	2 ICLK
0008 860Fh	MTU	Timer output control register 2	TOCR2	8	8	2, 3 PCLKB	2 ICLK
0008 8610h	MTU3	Timer counter	TCNT	16	16	2, 3 PCLKB	2 ICLK
0008 8612h	MTU4	Timer counter	TCNT	16	16	2, 3 PCLKB	2 ICLK
0008 8614h	MTU	Timer cycle data register	TCDR	16	16	2, 3 PCLKB	2 ICLK
0008 8616h	MTU	Timer dead time data register	TDDR	16	16	2, 3 PCLKB	2 ICLK
0008 8618h	MTU3	Timer general register A	TGRA	16	16	2, 3 PCLKB	2 ICLK
0008 861Ah	MTU3	Timer general register B	TGRB	16	16	2, 3 PCLKB	2 ICLK
0008 861Ch	MTU4	Timer general register A	TGRA	16	16	2, 3 PCLKB	2 ICLK
0008 861Eh	MTU4	Timer general register B	TGRB	16	16	2, 3 PCLKB	2 ICLK
0008 8620h	MTU	Timer subcounter	TCNTS	16	16	2, 3 PCLKB	2 ICLK
0008 8622h	MTU	Timer cycle buffer register	TCBR	16	16	2, 3 PCLKB	2 ICLK
0008 8624h	MTU3	Timer general register C	TGRC	16	16	2, 3 PCLKB	2 ICLK
0008 8626h	MTU3	Timer general register D	TGRD	16	16	2, 3 PCLKB	2 ICLK
0008 8628h	MTU4	Timer general register C	TGRC	16	16	2, 3 PCLKB	2 ICLK
0008 862Ah	MTU4	Timer general register D	TGRD	16	16	2, 3 PCLKB	2 ICLK
0008 862Ch	MTU3	Timer status register	TSR	8	8	2, 3 PCLKB	2 ICLK
0008 862Dh	MTU4	Timer status register	TSR	8	8	2, 3 PCLKB	2 ICLK

Table 4.1 List of I/O Registers (Address Order) (13 / 24)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access Cycles: ICLK ≥ PCLK	Number of Access Cycles: ICLK < PCLK
0008 8630h	MTU	Timer interrupt skipping set register	TITCR	8	8	2, 3 PCLKB	2 ICLK
0008 8631h	MTU	Timer interrupt skipping counter	TITCNT	8	8	2, 3 PCLKB	2 ICLK
0008 8632h	MTU	Timer buffer transfer set register	TBTER	8	8	2, 3 PCLKB	2 ICLK
0008 8634h	MTU	Timer dead time enable register	TDER	8	8	2, 3 PCLKB	2 ICLK
0008 8636h	MTU	Timer output level buffer register	TOLBR	8	8	2, 3 PCLKB	2 ICLK
0008 8638h	MTU3	Timer buffer operation transfer mode register	TBTM	8	8	2, 3 PCLKB	2 ICLK
0008 8639h	MTU4	Timer buffer operation transfer mode register	TBTM	8	8	2, 3 PCLKB	2 ICLK
0008 8640h	MTU4	Timer A/D converter start request control register	TADCR	16	16	2, 3 PCLKB	2 ICLK
0008 8644h	MTU4	Timer A/D converter start request cycle set register A	TADCORA	16	16	2, 3 PCLKB	2 ICLK
0008 8646h	MTU4	Timer A/D converter start request cycle set register B	TADCORB	16	16	2, 3 PCLKB	2 ICLK
0008 8648h	MTU4	Timer A/D converter start request cycle set buffer register A	TADCOBRA	16	16	2, 3 PCLKB	2 ICLK
0008 864Ah	MTU4	Timer A/D converter start request cycle set buffer register B	TADCOBRB	16	16	2, 3 PCLKB	2 ICLK
0008 8660h	MTU	Timer waveform control register	TWCR	8	8, 16	2, 3 PCLKB	2 ICLK
0008 8680h	MTU	Timer start register	TSTR	8	8, 16	2, 3 PCLKB	2 ICLK
0008 8681h	MTU	Timer synchronous register	TSYR	8	8, 16	2, 3 PCLKB	2 ICLK
0008 8684h	MTU	Timer read/write enable register	TRWER	8	8, 16	2, 3 PCLKB	2 ICLK
0008 8690h	MTU0	Noise filter control register	NFCR	8	8, 16	2, 3 PCLKB	2 ICLK
0008 8691h	MTU1	Noise filter control register	NFCR	8	8, 16	2, 3 PCLKB	2 ICLK
0008 8692h	MTU2	Noise filter control register	NFCR	8	8, 16	2, 3 PCLKB	2 ICLK
0008 8693h	MTU3	Noise filter control register	NFCR	8	8, 16	2, 3 PCLKB	2 ICLK
0008 8694h	MTU4	Noise filter control register	NFCR	8	8, 16	2, 3 PCLKB	2 ICLK
0008 8695h	MTU5	Noise filter control register	NFCR	8	8, 16	2, 3 PCLKB	2 ICLK
0008 8700h	MTU0	Timer control register	TCR	8	8	2, 3 PCLKB	2 ICLK
0008 8701h	MTU0	Timer mode register	TMDR	8	8	2, 3 PCLKB	2 ICLK
0008 8702h	MTU0	Timer I/O control register H	TIORH	8	8	2, 3 PCLKB	2 ICLK
0008 8703h	MTU0	Timer I/O control register L	TIORL	8	8	2, 3 PCLKB	2 ICLK
0008 8704h	MTU0	Timer interrupt enable register	TIER	8	8	2, 3 PCLKB	2 ICLK
0008 8705h	MTU0	Timer status register	TSR	8	8	2, 3 PCLKB	2 ICLK
0008 8706h	MTU0	Timer counter	TCNT	16	16	2, 3 PCLKB	2 ICLK
0008 8708h	MTU0	Timer general register A	TGRA	16	16	2, 3 PCLKB	2 ICLK
0008 870Ah	MTU0	Timer general register B	TGRB	16	16	2, 3 PCLKB	2 ICLK
0008 870Ch	MTU0	Timer general register C	TGRC	16	16	2, 3 PCLKB	2 ICLK
0008 870Eh	MTU0	Timer general register D	TGRD	16	16	2, 3 PCLKB	2 ICLK
0008 8720h	MTU0	Timer general register E	TGRE	16	16	2, 3 PCLKB	2 ICLK
0008 8722h	MTU0	Timer general register F	TGRF	16	16	2, 3 PCLKB	2 ICLK
0008 8724h	MTU0	Timer interrupt enable register 2	TIER2	8	8	2, 3 PCLKB	2 ICLK
0008 8726h	MTU0	Timer buffer operation transfer mode register	TBTM	8	8	2, 3 PCLKB	2 ICLK
0008 8780h	MTU1	Timer control register	TCR	8	8	2, 3 PCLKB	2 ICLK
0008 8781h	MTU1	Timer mode register	TMDR	8	8	2, 3 PCLKB	2 ICLK
0008 8782h	MTU1	Timer I/O control register	TIOR	8	8	2, 3 PCLKB	2 ICLK
0008 8784h	MTU1	Timer interrupt enable register	TIER	8	8	2, 3 PCLKB	2 ICLK
0008 8785h	MTU1	Timer status register	TSR	8	8	2, 3 PCLKB	2 ICLK
0008 8786h	MTU1	Timer counter	TCNT	16	16	2, 3 PCLKB	2 ICLK
0008 8788h	MTU1	Timer general register A	TGRA	16	16	2, 3 PCLKB	2 ICLK
0008 878Ah	MTU1	Timer general register B	TGRB	16	16	2, 3 PCLKB	2 ICLK
0008 8790h	MTU1	Timer input capture control register	TICCR	8	8	2, 3 PCLKB	2 ICLK
0008 8800h	MTU2	Timer control register	TCR	8	8	2, 3 PCLKB	2 ICLK
0008 8801h	MTU2	Timer mode register	TMDR	8	8	2, 3 PCLKB	2 ICLK
0008 8802h	MTU2	Timer I/O control register	TIOR	8	8	2, 3 PCLKB	2 ICLK
0008 8804h	MTU2	Timer interrupt enable register	TIER	8	8	2, 3 PCLKB	2 ICLK
0008 8805h	MTU2	Timer status register	TSR	8	8	2, 3 PCLKB	2 ICLK

Table 4.1 List of I/O Registers (Address Order) (19 / 24)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access Cycles: ICLK ≥ PCLK	Number of Access Cycles: ICLK < PCLK
0008 C042h	PORT2	Port input data register	PIDR	8	8	3 or 4 PCLKB cycles when reading, 2 or 3 PCLKB cycles when writing	3 ICLK cycles when reading, 2 ICLK cycles when writing
0008 C043h	PORT3	Port input data register	PIDR	8	8	3 or 4 PCLKB cycles when reading, 2 or 3 PCLKB cycles when writing	3 ICLK cycles when reading, 2 ICLK cycles when writing
0008 C044h	PORT4	Port input data register	PIDR	8	8	3 or 4 PCLKB cycles when reading, 2 or 3 PCLKB cycles when writing	3 ICLK cycles when reading, 2 ICLK cycles when writing
0008 C045h	PORT5	Port input data register	PIDR	8	8	3 or 4 PCLKB cycles when reading, 2 or 3 PCLKB cycles when writing	3 ICLK cycles when reading, 2 ICLK cycles when writing
0008 C04Ah	PORTA	Port input data register	PIDR	8	8	3 or 4 PCLKB cycles when reading, 2 or 3 PCLKB cycles when writing	3 ICLK cycles when reading, 2 ICLK cycles when writing
0008 C04Bh	PORTB	Port input data register	PIDR	8	8	3 or 4 PCLKB cycles when reading, 2 or 3 PCLKB cycles when writing	3 ICLK cycles when reading, 2 ICLK cycles when writing
0008 C04Ch	PORTC	Port input data register	PIDR	8	8	3 or 4 PCLKB cycles when reading, 2 or 3 PCLKB cycles when writing	3 ICLK cycles when reading, 2 ICLK cycles when writing
0008 C04Eh	PORTE	Port input data register	PIDR	8	8	3 or 4 PCLKB cycles when reading, 2 or 3 PCLKB cycles when writing	3 ICLK cycles when reading, 2 ICLK cycles when writing
0008 C051h	PORTH	Port input data register	PIDR	8	8	3 or 4 PCLKB cycles when reading, 2 or 3 PCLKB cycles when writing	3 ICLK cycles when reading, 2 ICLK cycles when writing
0008 C052h	PORTJ	Port input data register	PIDR	8	8	3 or 4 PCLKB cycles when reading, 2 or 3 PCLKB cycles when writing	3 ICLK cycles when reading, 2 ICLK cycles when writing
0008 C060h	PORT0	Port mode register	PMR	8	8	2, 3 PCLKB	2 ICLK
0008 C061h	PORT1	Port mode register	PMR	8	8	2, 3 PCLKB	2 ICLK
0008 C062h	PORT2	Port mode register	PMR	8	8	2, 3 PCLKB	2 ICLK
0008 C063h	PORT3	Port mode register	PMR	8	8	2, 3 PCLKB	2 ICLK
0008 C064h	PORT4	Port mode register	PMR	8	8	2, 3 PCLKB	2 ICLK
0008 C065h	PORT5	Port mode register	PMR	8	8	2, 3 PCLKB	2 ICLK
0008 C06Ah	PORTA	Port mode register	PMR	8	8	2, 3 PCLKB	2 ICLK
0008 C06Bh	PORTB	Port mode register	PMR	8	8	2, 3 PCLKB	2 ICLK
0008 C06Ch	PORTC	Port mode register	PMR	8	8	2, 3 PCLKB	2 ICLK
0008 C06Eh	PORTE	Port mode register	PMR	8	8	2, 3 PCLKB	2 ICLK
0008 C071h	PORTH	Port mode register	PMR	8	8	2, 3 PCLKB	2 ICLK
0008 C072h	PORTJ	Port mode register	PMR	8	8	2, 3 PCLKB	2 ICLK
0008 C082h	PORT1	Open drain control register 0	ODR0	8	8, 16	2, 3 PCLKB	2 ICLK
0008 C083h	PORT1	Open drain control register 1	ODR1	8	8, 16	2, 3 PCLKB	2 ICLK
0008 C084h	PORT2	Open drain control register 0	ODR0	8	8, 16	2, 3 PCLKB	2 ICLK
0008 C085h	PORT2	Open drain control register 1	ODR1	8	8, 16	2, 3 PCLKB	2 ICLK
0008 C086h	PORT3	Open drain control register 0	ODR0	8	8, 16	2, 3 PCLKB	2 ICLK
0008 C087h	PORT3	Open drain control register 1	ODR1	8	8, 16	2, 3 PCLKB	2 ICLK
0008 C094h	PORTA	Open drain control register 0	ODR0	8	8, 16	2, 3 PCLKB	2 ICLK
0008 C095h	PORTA	Open drain control register 1	ODR1	8	8, 16	2, 3 PCLKB	2 ICLK
0008 C096h	PORTB	Open drain control register 0	ODR0	8	8, 16	2, 3 PCLKB	2 ICLK
0008 C097h	PORTB	Open drain control register 1	ODR1	8	8, 16	2, 3 PCLKB	2 ICLK
0008 C098h	PORTC	Open drain control register 0	ODR0	8	8, 16	2, 3 PCLKB	2 ICLK
0008 C099h	PORTC	Open drain control register 1	ODR1	8	8, 16	2, 3 PCLKB	2 ICLK
0008 C09Dh	PORTE	Open drain control register 1	ODR1	8	8, 16	2, 3 PCLKB	2 ICLK

5. Electrical Characteristics

5.1 Absolute Maximum Ratings

Table 5.1 Absolute Maximum Ratings

Conditions: VSS = AVSS0 = AVSSA = VREFL = VREFL0 = VREFDSL = 0 V

Item	Symbol	Value	Unit
Power supply voltage	VCC	–0.3 to +6.5	V
Input voltage (except for ports for 5 V tolerant*1)	V_{in}	–0.3 to VCC + 0.3*3	V
Input voltage (ports for 5 V tolerant*1)	V_{in}	–0.3 to +6.5	V
Reference power supply voltage	VREFH, VREFH0	–0.3 to VCC + 0.3*3	V
Analog power supply voltage	AVCC0, AVCCA, BGR_BO*2	–0.3 to +6.5	V
A/D converter analog input voltage	V_{AN}	–0.3 to VCC + 0.3*3	V
ΔΣ A/D converter analog input voltage	V_{ANDS}	–0.6 to VCC + 0.3*3	V
Operating temperature	T_{opr}	–40 to +105	°C
Storage temperature	T_{stg}	–55 to +125	°C

Caution: Permanent damage to the LSI may result if absolute maximum ratings are exceeded.

To preclude any malfunctions due to noise interferences, insert capacitors of high frequency characteristics between the VCC and VSS pins, between the AVCC0 and AVSS0 pins, the AVCCA and AVSSA pins, and between the VREFH0 and VREFL0 pins. Place capacitors of 0.1 µF or so as close to every power pin and use the shortest and heaviest possible traces.

Connect the VCL pin to a VSS pin via a 0.1 µF (±20% accuracy) capacitor. The capacitor must be placed as close to the pin as possible.

Note 1. Ports 12, 13, 16, 17, 20, and 21 are 5 V tolerant.

Note 2. Set AVCC0 and AVCCA to the same potential as VCC. When neither the A/D converter, the D/A converter, nor ΔΣ A/D converter is in use, do not leave the AVCC0, VREFH, AVCCA, VREFH0, AVSS0, VREFL, AVSSA, and VREFL0 pins open. Connect the AVCC0, VREFH, AVCCA, and VREFH0 pins to VCC, and the AVSS0, VREFL, AVSSA, and VREFL0 pins to VSS, respectively.

Note 3. The maximum value is 6.5 V.

Item					Symbol	Typ.	Max.	Unit	Test Conditions
Supply current*1	Low-speed operating mode 1	Normal operating mode	No peripheral operation*6	ICLK = 8 MHz	I_{CC}	1.9	—	mA	
				ICLK = 4 MHz		1.2	—		
			All peripheral operation: Normal*7	ICLK = 8 MHz		2.5	—		
				ICLK = 4 MHz		1.7	—		
			All peripheral operation: Max.*8	ICLK = 8 MHz		—	12		
		Sleep mode	No peripheral operation	ICLK = 8 MHz		1.3	—		
				ICLK = 4 MHz		0.9	—		
			All peripheral operation: Normal	ICLK = 8 MHz		1.9	—		
				ICLK = 4 MHz		1.3	—		
		All-module clock stop mode		ICLK = 8 MHz		1.1	—		
				ICLK = 4 MHz		0.9	—		
	Low-speed operating mode 2	Normal operating mode	No peripheral operation*9	ICLK = 32 kHz		0.027	—		
			All peripheral operation: Normal*10	ICLK = 32 kHz		0.030	—		
			All peripheral operation: Max.*11	ICLK = 32 kHz		—	1.0		
		Sleep mode	No peripheral operation	ICLK = 32 kHz		0.022	—		
			All peripheral operation: Normal	ICLK = 32 kHz		0.025	—		
		All-module clock stop mode		ICLK = 32 kHz		0.022	—		

Note 1. Supply current values do not include output charge/discharge current from all pins. The values apply when internal pull-up MOSs are in the off state.
Note 2. This is the increase if data is programmed to or erasing from the ROM or E2 DataFlash during program execution.
Note 3. Clock supply to the peripheral functions is stopped. This does not include BGO operation. The clock source is HOCO. FCLK and PCLK are set to divided by 64.
Note 4. Clocks are supplied to the peripheral functions. This does not include BGO operation. The clock source is HOCO. FCLK and PCLK are set to divided by 64.
Note 5. Clocks are supplied to the peripheral functions. This does not include BGO operation. The clock source is PLL. FCLK and PCLK are ICLK divided by 1.
Note 6. Clock supply to the peripheral functions is stopped. This does not include BGO operation. The clock source is the main oscillation circuit. FCLK and PCLK are set to divided by 64.
Note 7. Clocks are supplied to the peripheral functions. This does not include BGO operation. The clock source is the main oscillation circuit. FCLK and PCLK are set to divided by 64.
Note 8. Clocks are supplied to the peripheral functions. This does not include BGO operation. The clock source is HOCO. FCLK and PCLK are ICLK divided by 1.
Note 9. Clock supply to the peripheral functions is stopped. This does not include BGO operation. The clock source is the sub oscillation circuit. FCLK and PCLK are set to divided by 64.
Note 10. Clocks are supplied to the peripheral functions. This does not include BGO operation. The clock source is the sub oscillation circuit. FCLK and PCLK are set to divided by 64.
Note 11. Clocks are supplied to the peripheral functions. This does not include BGO operation. The clock source is the main oscillation circuit. FCLK and PCLK are ICLK divided by 1.

Table 5.8 DC Characteristics (7)

Conditions: VCC = AVCC0 = AVCCA = 1.8 to 3.6 V, VSS = AVSS0 = AVSSA = VREFL = VREFL0 = VREFDSL = 0 V,
T_a = –40 to +105°C

Item				Symbol	Typ.*3	Max.	Unit	Test Conditions
Supply current*1	Software standby mode*2	Flash memory power supplied, HOCO power supplied, POR low power consumption function disabled (SOFTCUT[2:0] bits = 000b)	T_a = 25°C	I_{CC}	10	20	µA	
			T_a = 55°C		12	41		
			T_a = 85°C		18	113		
			T_a = 105°C		29	233		
		Flash memory power supplied, HOCO power not supplied, POR low power consumption function enabled (SOFTCUT[2:0] bits = 110b)	T_a = 25°C		1.7	7.9		
			T_a = 55°C		2.7	25		
			T_a = 85°C		7.0	86		
			T_a = 105°C		16	189		
	Deep software standby mode*2	Flash memory power not supplied, HOCO power not supplied, POR low power consumption function enabled	T_a = 25°C		0.3	0.8		
			T_a = 55°C		0.4	1.1		
			T_a = 85°C		0.8	2.2		
			T_a = 105°C		1.3	4.7		
	Increments produced by running voltage detection circuits and disabling the POR low power consumption function				1.2	—		
	Increment for RTC operation (low CL)				0.6	—		
	Increment for RTC operation (standard CL)				1.4	—		

Note 1. Supply current values are with all output pins unloaded and all input pull-up MOSs in the off state.
Note 2. The IWDT and LVD are stopped.
Note 3. VCC = 3.3 V.

5.2.1 Standard I/O Pin Output Characteristics (1)

Figure 5.11 to Figure 5.15 show the characteristics when normal output is selected by the drive capacity control register.

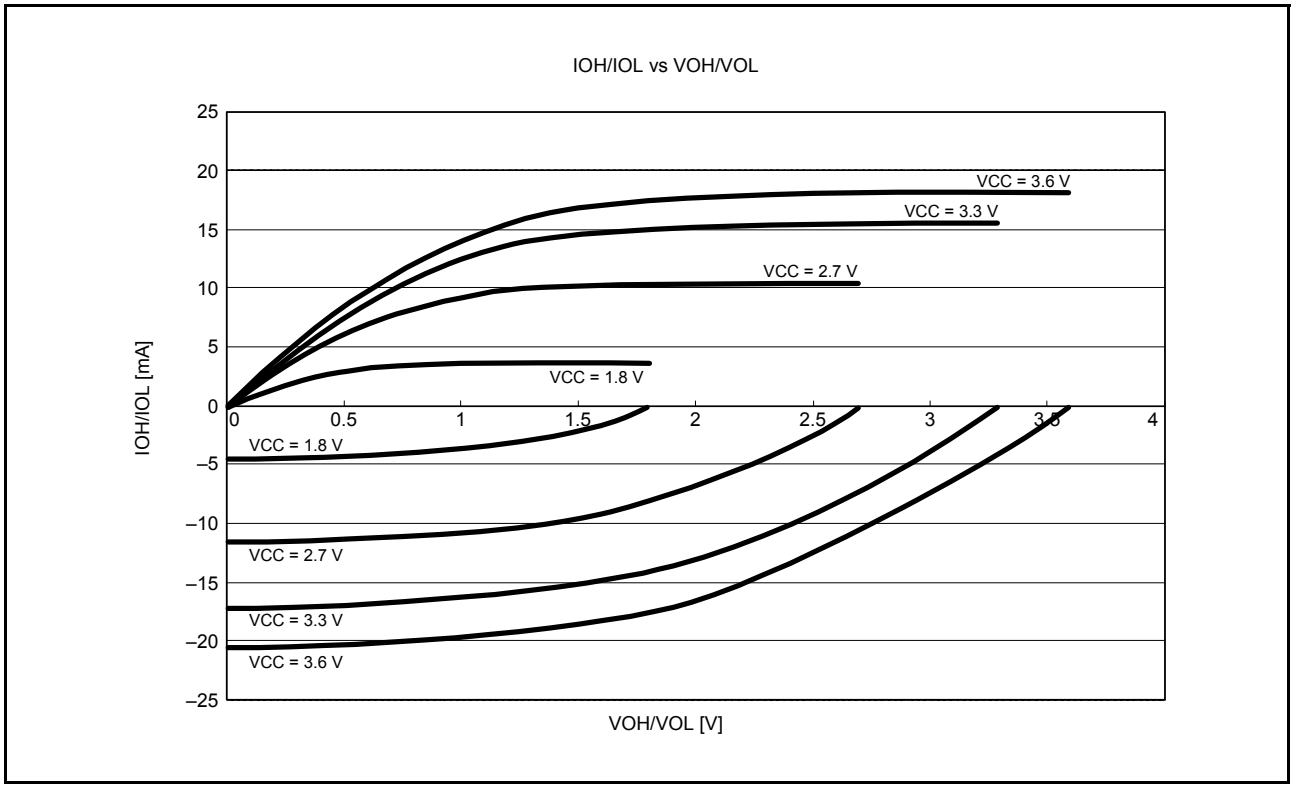


Figure 5.11 VOH/VOL and IOH/IOL Voltage Characteristics at Ta = 25°C when Normal Output is Selected (Reference Data)

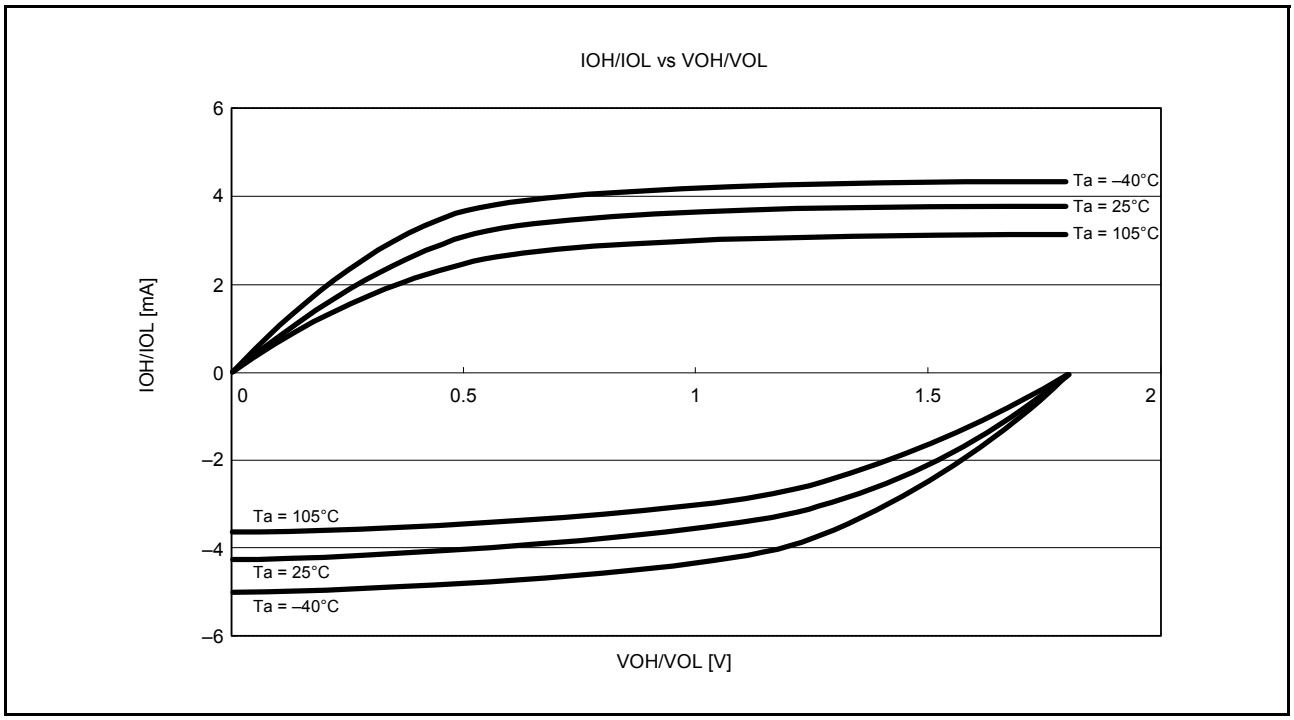


Figure 5.12 VOH/VOL and IOH/IOL Temperature Characteristics at VCC = 1.8 V when Normal Output is Selected (Reference Data)

Table 5.22 Operation Frequency Value (Medium-Speed Operating Mode 2A)

Conditions: VCC = AVCC0 = AVCCA = 1.8 to 3.6 V, VSS = AVSS0 = AVSSA = VREFL = VREFL0 = VREFDSL = 0 V,
T_a = –40 to +105°C

Item		Symbol	VCC		Unit
			1.8 to 2.7 V	2.7 to 3.6 V	
Maximum operating frequency	System clock (ICLK)	f_{max}	12.5	25	MHz
	FlashIF clock (FCLK)*1		12.5	25	
	Peripheral module clock (PCLKA)		12.5	25	
	Peripheral module clock (PCLKB)		12.5	25	
	Peripheral module clock (PCLKC)*2		12.5	25	
	Peripheral module clock (PCLKD)*3		12.5	25	

Note 1. The VCC is 2.7 to 3.6 V and the lower-limit frequency of FCLK is 4 MHz during programming or erasing of the flash memory.
Note 2. The frequency of PCLKC is 25 MHz when the ΔΣ A/D converter is in use.
Note 3. The lower-limit frequency of PCLKD is 1 MHz when the A/D converter is in use.

Table 5.23 Operation Frequency Value (Medium-Speed Operating Mode 2B)

Conditions: VCC = AVCC0 = AVCCA = 1.8 to 3.6 V, VSS = AVSS0 = AVSSA = VREFL = VREFL0 = VREFDSL = 0 V,
T_a = –40 to +105°C

Item		Symbol	VCC		Unit
			1.8 to 2.7 V	2.7 to 3.6 V	
Maximum operating frequency	System clock (ICLK)	f_{max}	12.5	25	MHz
	FlashIF clock (FCLK)*1		12.5	25	
	Peripheral module clock (PCLKA)		12.5	25	
	Peripheral module clock (PCLKB)		12.5	25	
	Peripheral module clock (PCLKC)*2		12.5	25	
	Peripheral module clock (PCLKD)*3		12.5	25	

Note 1. The lower-limit frequency of FCLK is 4 MHz during programming or erasing of the flash memory.
Note 2. The frequency of PCLKC is 25 MHz when the ΔΣ A/D converter is in use.
Note 3. The lower-limit frequency of PCLKD is 1 MHz when the A/D converter is in use.

5.4.1 Reset Timing

Table 5.27 Reset Timing

Conditions: VCC = AVCC0 = AVCCA = 1.8 to 3.6 V, VSS = AVSS0 = AVSSA = VREFL = VREFL0 = VREFDSL = 0 V,
T_a = –40 to +105°C

Item		Symbol	Min.	Typ.	Max.	Unit	Test Conditions
RES# pulse width	Power-on	t_{RESWP}	8	—	—	ms	Figure 5.35
	Deep software standby mode	t_{RESWD}	8	—	—	ms	Figure 5.36
	Software standby mode, low-speed operating modes 1 and 2	t_{RESWS}	1	—	—	ms	
	Programming or erasure of the ROM or E2 DataFlash memory or blank checking of the E2 DataFlash memory	t_{RESWF}	200	—	—	µs	
	Other than above	t_{RESW}	200	—	—	µs	
Wait time after RES# cancellation		t_{RESWT}	—	—	912	µs	Figure 5.35
Internal reset time (independent watchdog timer reset, watchdog timer reset, software reset)		t_{RESW2}	—	—	1.4	ms	

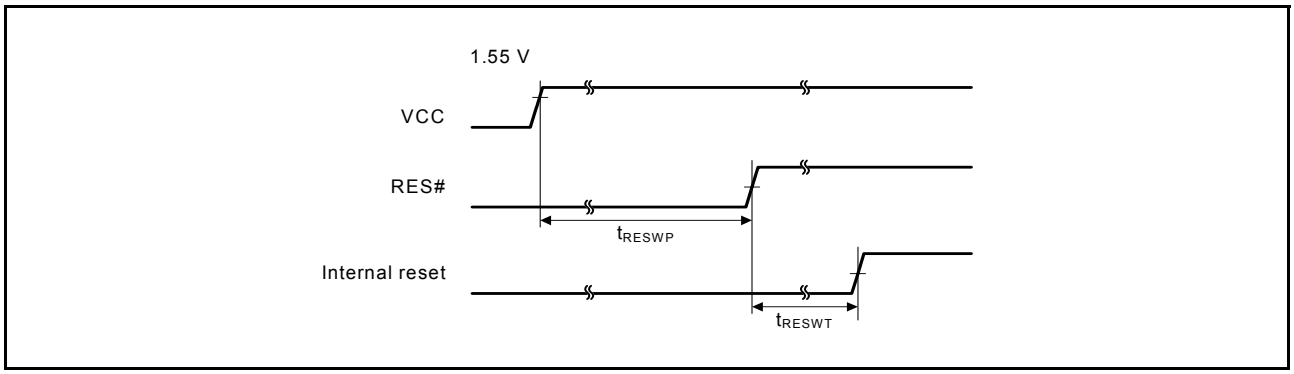


Figure 5.35 Reset Input Timing at Power-On

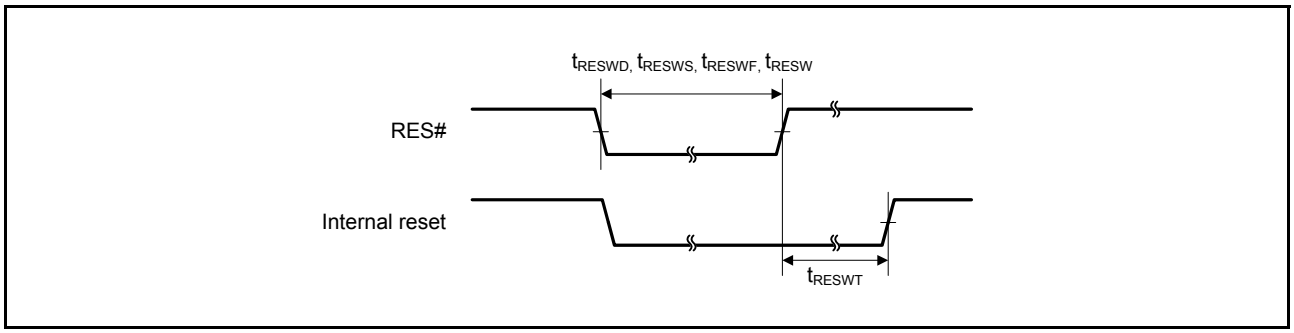


Figure 5.36 Reset Input Timing

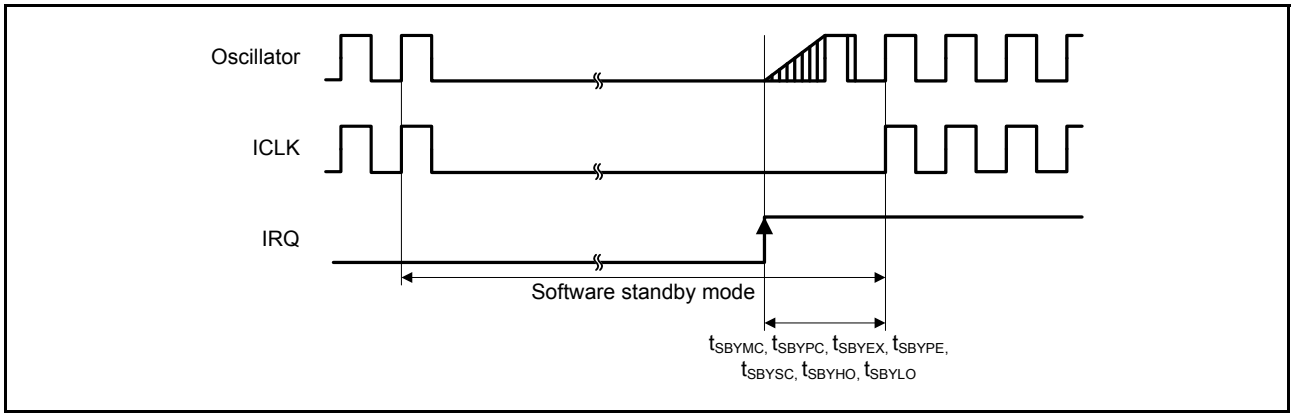


Figure 5.37 Software Standby Mode Cancellation Timing

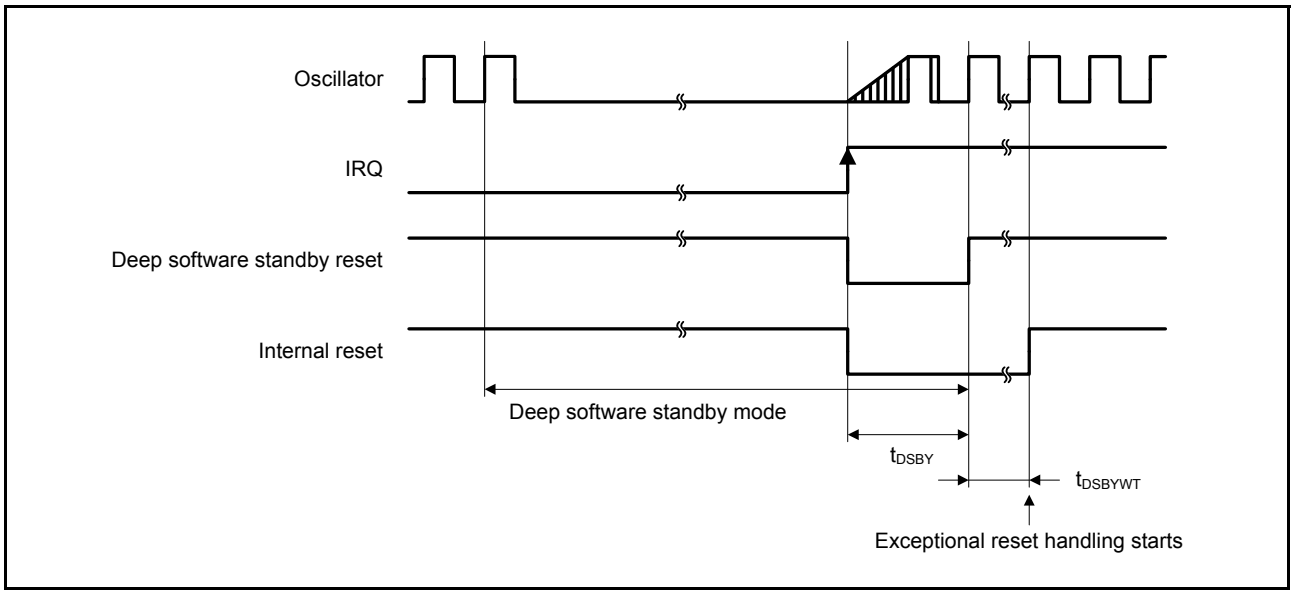


Figure 5.38 Deep Software Standby Mode Cancellation Timing

Table 5.33 Timing of On-Chip Peripheral Modules (4)

Conditions: VCC = AVCC0 = AVCCA = 1.8 to 3.6 V, VSS = AVSS0 = AVSSA = VREFL = VREFL0 = VREFDSL = 0 V,
T_a = –40 to +105°C
When high-drive output is selected by the drive capacity register while 1.8 V ≤ VCC < 2.7 V

Item			Symbol	Min.	Max.	Unit*1	Test Conditions
Simple SPI	SCK clock cycle output (master)		t_{SPcyc}	4	65536	t_{Pcyc}	C = 30 pF Figure 5.49
	SCK clock cycle input (slave)			6	65536		
	SCK clock high pulse width		t_{SPCKWH}	0.4	0.6	t_{SPcyc}	
	SCK clock low pulse width		t_{SPCKWL}	0.4	0.6	t_{SPcyc}	
	SCK clock rise/fall time		t_{SPCKr}, t_{SPCKf}	—	20	ns	
	Data input setup time (Master)	2.7 V ≤ VCC ≤ 3.6 V	t_{SU}	65	—	ns	C = 30 pF Figure 5.50 to Figure 5.53
		1.8 V ≤ VCC < 2.7 V		75	—		
	Data input setup time (Slave)			40	—		
	Data input hold time		t_H	40	—	ns	
	SS input setup time		t_{LEAD}	6	—	t_{Pcyc}	
	SS input hold time		t_{LAG}	6	—	t_{Pcyc}	
	Data output delay time (Master)		t_{OD}	—	40	ns	
	Data output delay time (Slave)	2.7 V ≤ VCC ≤ 3.6 V		—	65		
		1.8 V ≤ VCC < 2.7 V		—	85		
	Data output hold time		t_{OH}	–10	—	ns	
	Data rise/fall time		t_{Dr}, t_{Df}	—	20	ns	
	SS input rise/fall time		t_{SSLr}, t_{SSLf}	—	20	ns	
	Slave access time		t_{SA}	—	5	t_{Pcyc}	C = 30 pF Figure 5.52 and Figure 5.53
	Slave output release time	2.7 V ≤ VCC ≤ 3.6 V	t_{REL}	—	5	t_{Pcyc}	
		1.8 V ≤ VCC < 2.7 V		—	6		

Note 1. t_{Pcyc}: PCLK cycle

5.5 ΔΣ A/D Conversion Characteristics

Table 5.36 ΔΣ A/D Conversion Characteristics

Conditions: VCC = AVCC0 = AVCCA = 2.7 to 3.6 V, VSS = AVSS0 = AVSSA = VREFL = VREFL0 = VREFDSL = 0 V, fPCLKC = 25 MHz, T_a = –40 to +105°C

Item	Min.	Typ.	Max.	Unit	Test Conditions
Resolution	24	24	24	Bit	
Reference voltage (VREFDSH)	590	600	610	mV	EXREF = 0
BGR_BO pin applied voltage	—	1220	—	mV	EXREF = 1
BGR_BO pin voltage to reference voltage conversion coefficient	—	0.492	—	—	EXREF = 1
BGR_BO pin impedance	135	—	—	kΩ	EXREF = 1
Reference voltage temperature coefficient	—	—	30	ppm/°C	
Gain (×1)	—	1.00	—	—	
Gain (×2)	—	2.00	—	—	
Gain (×4)	—	4.00	—	—	
Gain (×8)	—	8.00	—	—	
Gain (×16)	—	16.00	—	—	
Gain (×32)	—	32.00	—	—	
Gain (×64)	—	64.00	—	—	
Differential input voltage (ANDSiP - ANDSiN) (i = 0 to 3)	–500.0	—	500.0	mV	GAIN = 000b, Figure 5.55
	–250.0	—	250.0	mV	GAIN = 001b
	–125.0	—	125.0	mV	GAIN = 010b
	–62.5	—	62.5	mV	GAIN = 011b
	–31.2	—	31.2	mV	GAIN = 100b
	–14.4	—	14.4	mV	GAIN = 101b
	–5.0	—	5.0	mV	GAIN = 110b
Differential input Common mode voltage	—	700.0	—	mV	
Single-ended input voltage	–500.0	—	500.0	mV	GAIN = 00b, Figure 5.56
	–250.0	—	250.0	mV	GAIN = 01b
	–125.0	—	125.0	mV	GAIN = 10b
Conversion with the ΔΣ modulator only Differential input voltage	–500.0	—	500.0	mV	GAIN = 000b, 001b, 010b, 011b, 100b (DSADGSR0 to 3) GAIN = 00b, 01b, 10b (DSADGSR4 to 6)
	–250.0	—	250.0	mV	GAIN = 101b (DSADGSR0 to 3)
	–125.0	—	125.0	mV	GAIN = 110b (DSADGSR0 to 3)
Conversion with the ΔΣ modulator only Common mode input voltage	—	700.0	—	mV	
PGA input pin bias voltage	—	700.0	—	mV	
PGA output common mode voltage	—	700.0	—	mV	
Reference voltage startup time	—	1	5	ms	
PGA and ΔΣ modulator startup time	—	—	0.1	ms	
Input pull-up resistor	120	200	—	kΩ	
Input impedance for differential input (×1, ×2, ×4, ×8)	40	66	—	kΩ	
Input impedance for differential input (×16, ×32, ×64)	30	50	—	kΩ	
Input impedance for single-ended input (×1)	48	80	—	kΩ	
Input impedance for single-ended input (×2)	51	86	—	kΩ	

5.12 ROM (Flash Memory for Code Storage) Characteristics

Table 5.47 ROM (Flash Memory for Code Storage) Characteristics (1)

Item		Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Reprogramming/erasure cycle*1		N_{PEC}	10000	—	—	Times	
Data hold time	After 1000 times of N_{PEC}	t_{DRP}	30*2	—	—	Year	Ta = +85°C
	After 10000 times of N_{PEC}		1*2	—	—		

Note 1. Definition of reprogram/erase cycle: The reprogram/erase cycle is the number of erasing for each block. When the reprogram/erase cycle is n times (n = 1000), erasing can be performed n times for each block. For instance, when 128-byte programming is performed 16 times for different addresses in 2-Kbyte block and then the entire block is erased, the reprogram/erase cycle is counted as one. However, programming the same address for several times as one erasing is not enabled (overwriting is prohibited).

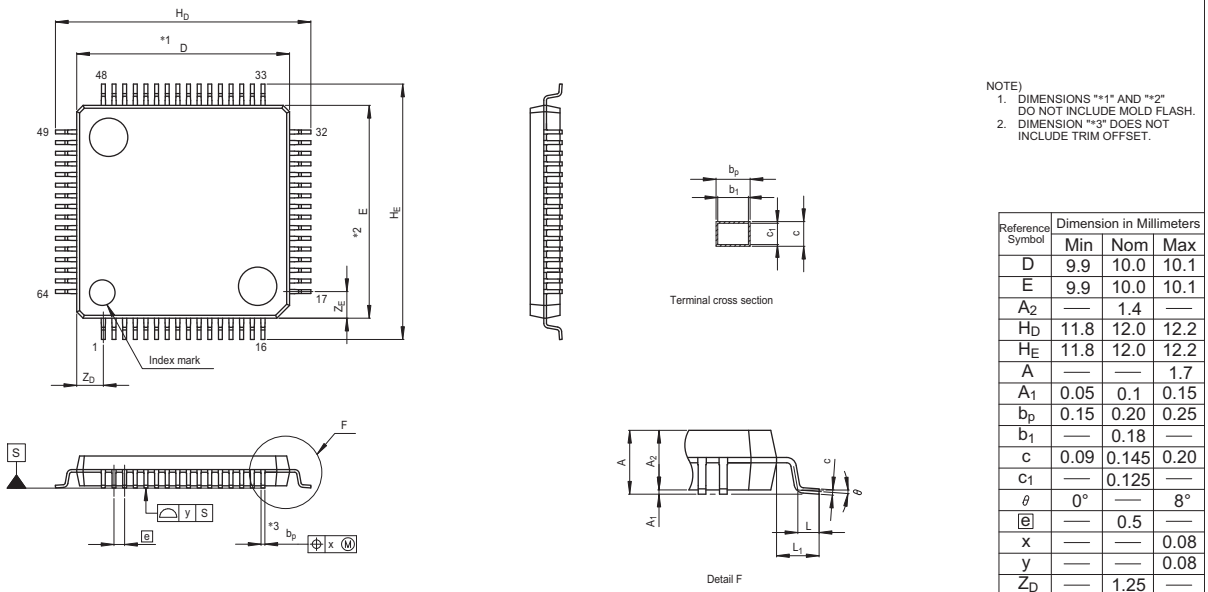
Note 2. This result is obtained from reliability testing.

Table 5.48 ROM (Flash Memory for Code Storage) Characteristics (2) : high-speed operating mode, medium-speed operating modes 1A and 2A

Conditions: VCC = AVCC0 = AVCCA = 2.7 to 3.6 V, VSS = AVSS0 = AVSSA = VREFL = VREFL0 = VREFDSL = 0 V
Temperature range for the programming/erasure operation: T_a = –40 to +105°C

Item		Symbol	FCLK = 4 MHz			FCLK = 25 MHz			Unit
			Min.	Typ.	Max.	Min.	Typ.	Max.	
Programming time when N_{PEC} ≤ 100 times	2 bytes	t_{P2}	—	0.19	4.3	—	0.12	2.1	ms
	8 bytes	t_{P8}	—	0.19	4.4	—	0.12	2.1	
	128 bytes	t_{P128}	—	0.67	10.7	—	0.42	5.0	
Programming time when N_{PEC} > 100 times	2 bytes	t_{P2}	—	0.23	5.3	—	0.15	2.6	ms
	8 bytes	t_{P8}	—	0.23	5.4	—	0.15	2.6	
	128 bytes	t_{P128}	—	0.80	13.2	—	0.50	6.3	
Erasure time when N_{PEC} ≤ 100 times	2 Kbytes	t_{E2K}	—	13.0	92.8	—	10.6	31.6	ms
Erasure time when N_{PEC} > 100 times	2 Kbytes	t_{E2K}	—	15.9	176.9	—	13.0	64.7	ms
Suspend delay time during programming (in programming/erasure priority mode)		t_{SPD}	—	—	0.9	—	—	0.804	ms
First suspend delay time during programming (in suspend priority mode)		t_{SPSD1}	—	—	220	—	—	124	µs
Second suspend delay time during programming (in suspend priority mode)		t_{SPSD2}	—	—	0.9	—	—	0.804	ms
Suspend delay time during erasing (in programming/erasure priority mode)		t_{SED}	—	—	0.9	—	—	0.804	ms
First suspend delay time during erasing (in suspend priority mode)		t_{SESD1}	—	—	220	—	—	124	µs
Second suspend delay time during erasing (in suspend priority mode)		t_{SESD2}	—	—	0.9	—	—	0.804	ms
FCU reset time		t_{FCUR}	20 µs or longer and FCLK × 6 or greater	—	—	20 µs or longer and FCLK × 6 or greater	—	—	µs

JEITA Package Code	RENESAS Code	Previous Code	MASS[Typ.]
P-LFQFP64-10x10-0.50	PLQP0064KB-A	64P6Q-A / FP-64K / FP-64KV	0.3g



NOTE)
1. DIMENSIONS "*1" AND "*2" DO NOT INCLUDE MOLD FLASH.
2. DIMENSION "*3" DOES NOT INCLUDE TRIM OFFSET.

Reference Symbol	Dimension in Millimeters		
	Min	Nom	Max
D	9.9	10.0	10.1
E	9.9	10.0	10.1
A_2	—	1.4	—
H_D	11.8	12.0	12.2
H_E	11.8	12.0	12.2
A	—	—	1.7
A_1	0.05	0.1	0.15
b_p	0.15	0.20	0.25
b_1	—	0.18	—
c	0.09	0.145	0.20
c_1	—	0.125	—
θ	0°	—	8°
e	—	0.5	—
x	—	—	0.08
y	—	—	0.08
Z_D	—	1.25	—
Z_E	—	1.25	—
L	0.35	0.5	0.65
L_1	—	1.0	—

Figure C 64-Pin LQFP (PLQP0064KB-A)

General Precautions in the Handling of MPU/MCU Products

The following usage notes are applicable to all MPU/MCU products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

1. Handling of Unused Pins

   Handle unused pins in accordance with the directions given under Handling of Unused Pins in the manual.

   — The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible. Unused pins should be handled as described under Handling of Unused Pins in the manual.

2. Processing at Power-on

   The state of the product is undefined at the moment when power is supplied.

   — The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the moment when power is supplied.
   In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the moment when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the moment when power is supplied until the power reaches the level at which resetting has been specified.

3. Prohibition of Access to Reserved Addresses

   Access to reserved addresses is prohibited.

   — The reserved addresses are provided for the possible future expansion of functions. Do not access these addresses; the correct operation of LSI is not guaranteed if they are accessed.

4. Clock Signals

   After applying a reset, only release the reset line after the operating clock signal has become stable. When switching the clock signal during program execution, wait until the target clock signal has stabilized.

   — When the clock signal is generated with an external resonator (or from an external oscillator) during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Moreover, when switching to a clock signal produced with an external resonator (or by an external oscillator) while program execution is in progress, wait until the target clock signal is stable.

5. Differences between Products

   Before changing from one product to another, i.e. to a product with a different part number, confirm that the change will not lead to problems.

   — The characteristics of an MPU or MCU in the same group but having a different part number may differ in terms of the internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.